Testbeam dE/dx Analysis



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Measuring Track dE/dx



- Valid hits for dE/dx measurement must
 - not be at module edge or next to central grid.
 - not have any overflow pulses.
 - not have any dead channels nor be next to one.
- Track dE/dx is calculated from a 20% truncated mean of remaining valid hits.
- In data the number of valid hits averages at ~56 (of 72 maximum).
- Resolution is determined from RMS after 5σ iterative cut of outliers to be ~8.5% (~8% for 56 hits only)





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Drift Dependency



- Some attachment is observed as mean dE/dx reduces with rising drift distance.
- dE/dx resolution is unaffected by this, as expected.





Track Length Dependency





- To estimate dE/dx resolution for the full scale ILD TPC hits from several tracks are combined.
- This allows to test arbitrary track lengths.
- A dependency on the number of hits of 1/N^x is found with X ranging from 0.45 to 0.5 between data runs.
- In simulation the exponent ranges from 0.47 to 0.5 between "runs".

• OPAL: 0.43

 Good agreement between data and simulation.



dE/dx Estimator Comparison





- TruncXX → cut of XX% of highest charge hits.
- TrimYY_XX → in addition cut of YY% of lowest charge hits.
- Inv / InvSqrt / InvSq → downweight Landau tail by taking inverse (square root / square) of hit charge.
- Best estimation methods are 20% truncation and trimming with 5% / 20%, as measured in simulation.
- In data inverted square root appears slightly better.
 - Simulated electronics do not handle overflow pulses accurately.



Charge Corrections





	Mean	RMS	RMS (%)
No Cor.	2044±49	374±35	18.3±1.8
RCC	2029±8	63±6	3.1±0.3
CC	2011±46	347±32	17.3±1.6
CRCC	1928±8	63±6	3.3±0.3

- Row Charge Correction (RCC) corrects mean charge on each row to the average charge of all rows.
- Channel Correction (CC) was determined by pulsing the common electrode of the lowest GEM with varying amplitudes to determine a correction factor.
 - Module 5 was not accessible.
- Channel Correction has no significant impact on the RMS of charge between rows.
- Row Charge Correction improves RMS to 3%.
- Combining both corrections (CRCC) yields no improvement over RCC alone.



Impact on dE/dx Resolution







Impact on dE/dx Resolution (2)





- Track length dependency is not changed significantly by corrections
- Generally resolution is not improved by the corrections.
- At fixed track length of 220 hits Row Charge Correction alone shows improvement, but not in combination with Channel Correction → under investigation.





- dE/dx resolution with the DESY GEM modules in the LP was successfully measured to be 8% for tracks with 56 usable hits.
- The optimal truncation fraction was found to be 20%.
 - Trimming also at the low charge end seems to give no improvement.
- Using the mean of $1/\sqrt{(dE/dx)}$ as an estimator to suppress the landau tail might be a valid alternative.
- A process to measure dE/dx resolution in dependency of the track length was established.
- From this the dE/dx resolution for the full ILD TPC (220 hits) was extrapolated to be ~4.5%.
- Charge calibrations (per channel / per row) yield no significant improvement on dE/dx resolution.
 - Expected, since it is dominated by primary ionisation fluctuations.
- Angular dependencies are still under investigation.





Additional Material





Overflow in Simulation









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- Charge and time calibration by pulsing the bottom-most GEM side
 - Tested before testbeam period with mock setup
 - Measurements with testbeam setup tricky (for 3rd module not possible),

since HV contacts had to be connected free-hand for pulsing the GEM

 \leftarrow ALTRO electronics and cables block easy access

Next module iteration should include easily accessible contact (over capacitor?) to bottom-most GEM layer



